



# Product Change Notification

## 108956 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 108956 - 00  
**Change Title:** Intel(R) Workstation Board BB5000XVN, S5000XVN, PCN 108956-00, Product Material, Heat Sink Change  
**Date of Publication:** October 26, 2008

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Nov 16, 2008
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## Description of Change to the Customer:

Intel is changing the Processor1/Processor2 Voltage Regulator heat sink on the Intel(R) Server Board S5000XVN from a non-anodized to anodized version. This heat sink is approximately 161mm long, 10.67mm wide, and 15.5mm high and comes attached to the server board on top of the Processor1/Processor2 Voltage Regulator (VR) Field Effect Transistors (FETs). The anodized version of the heat sink is black in appearance and has improved thermal conductivity and electrical insulation characteristics. The part number for the VR Heat sink is changing from Intel part number D17794-001 to D57771-003

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customer

## Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change MM#	Post Change TA	Post Change PBA
S5000XVNSASR 891986	891986	E12276-003	E11034-103	891986	E12276-004	E11034-104
S5000XVNSATAR 891999	891999	E12278-003	E11030-103	891999	E12278-004	E11030-104
BB5000XVNSASR 900393	900393	E12388-103	E11034-103	900393	E12388-104	E11034-104
BB5000XVNSATAR 900395	900395	E12391-103	E11030-103	900395	E12391-104	E11030-104

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**Reference Documents / Attachments:**

**Document:** \_\_\_\_\_ **Location #:** \_\_\_\_\_

**PCN Revision History:**

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
October 26, 2008	00	Originally Published PCN